

Features

- Bi-directional crowbar transient voltage protection
- High surge capability
- High off-state impedance
- Low leakage current
- Low on-state voltage
- Short-circuit failure mode
- Ultra Low Capacitance (Typ:55.0pF)



DO-214AA(SMB)

Main Application

JKSEMI's thyristor surge protector devices are designed to help protect sensitive telecommunication equipment from the hazards caused by lighning ,power contact, and power induction. These devices enable equipment to comply with various regulatory requirements including GR 1089,ITU K.20,K.21and K.45,IEC 60950,UL 60950,and TIA-968-A(formerly known as FCC Part 68).

Typical application including:

- Central office switching equipment. Analog and digital linecards(xDSL,T1/E1,ISDN.....)
- Customer Premises Equipment (CPE) such as phones, fax machines, modems, POS terminals, PBX systems and caller ID adjunct boxes.
- Primary protection modules including Main Distribution Frames(MDF), building entrance equipment and station protection modules.
- Access network equipment such as remote terminals, line repeaters, multiplexers, cross-connects, WAN equipment, Network Interface Devices (NID).
- Data lines and security systems.
- CATV line amplifiers and power inserters.
- Sprinkler systems.

Electrcal Parameters (Tamb=25°C)

Part Number	Vdrm Min.	Idrm Max.	Vво Max.	Ibo Max.	VT Max.	IT Max.	Co Typ.	`Ін Min.
	V	uA	V	mA	V	Α	pF	mA
PE06SB	6	2	15	800	3	2.2	55	30



Thyistor Surge Protector (PE06SB Series)

Part Number	Vdrm Min.	Idrm Max.	Vво Max.	Ibo Max.	VT Max.	Iт Max.	Co Max.	`Ін Min.
	V	uA	V	mA	V	Α	pF	mA

Eletrical Characteristics

Vdrm	Stand-off voltage, is measured at IDRM	Ін	Holding current.
VBO	Breakover voltage, is measured at 100V/ $\mu s.$	Іво	Breadover current.
Co	Off-state capacitance ismeasured in VDC=2V@1MHZ.	Iτ	ON-state current
IDRM	Leakage current, is measured at VDRM.	VT	On-state voltage.

Part Numbering System



(A) Jksemi's Semiconductor Surge Arrester;

(B) Series:0060etc.

- (C) Package:DO-214AA(SMB)
- (D) Rating Sure Voltage:B:4KV(10/700µs)



Electrical Characteristics Curves

Figure1 V-I Characteristics



Figure 3Normalized Vs Change versusJunctionTemperature



Figure 4 Normalized DC Holding Current



Thermal Considerations

Package DO-214AA/SMB	Package DO-214AA/SMB Symbol Parameter		Value	Unit
	TJ	Operating Junction Temperature	-40 to +150	°C
	Ts	Storage Temperature Range	-40 to +150	°C
	Reja	Junction to Ambient on printed circuit	90	°C/W



Solder Reflow Recommendations



Product Dimensions

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum
 - temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard

industry methods and solvents.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Dimension	Inc	hes	Millimeters		
Dimension	Min	Мах	Min	Мах	
А	0.134	0.155	3.40	3.94	
В	0.205	0.22	5.21	5.59	
С	0.075	0.083	1.90	2.11	
D	0.166	0.185	4.22	4.70	
Е	0.036	0.056	0.91	1.42	
F	0.073	0.087	1.85	2.2	
G	0.002	0.008	0.05	0.20	
Н	0.077	0.094	1.95	2.40	
J	0.043	0.053	1.09	1.35	
K	0.008	0.014	0.20	0.35	
L	0.039	0.049	0.99	1.24	



(2.0)

Summary of Packing Options

Package Type	Description	Packing Quantity	Industry Standard
DO-214AA	Embossed Carrier Reel Pack	3000PCS	EIA-481-D